

REPLACEMENT SHEET

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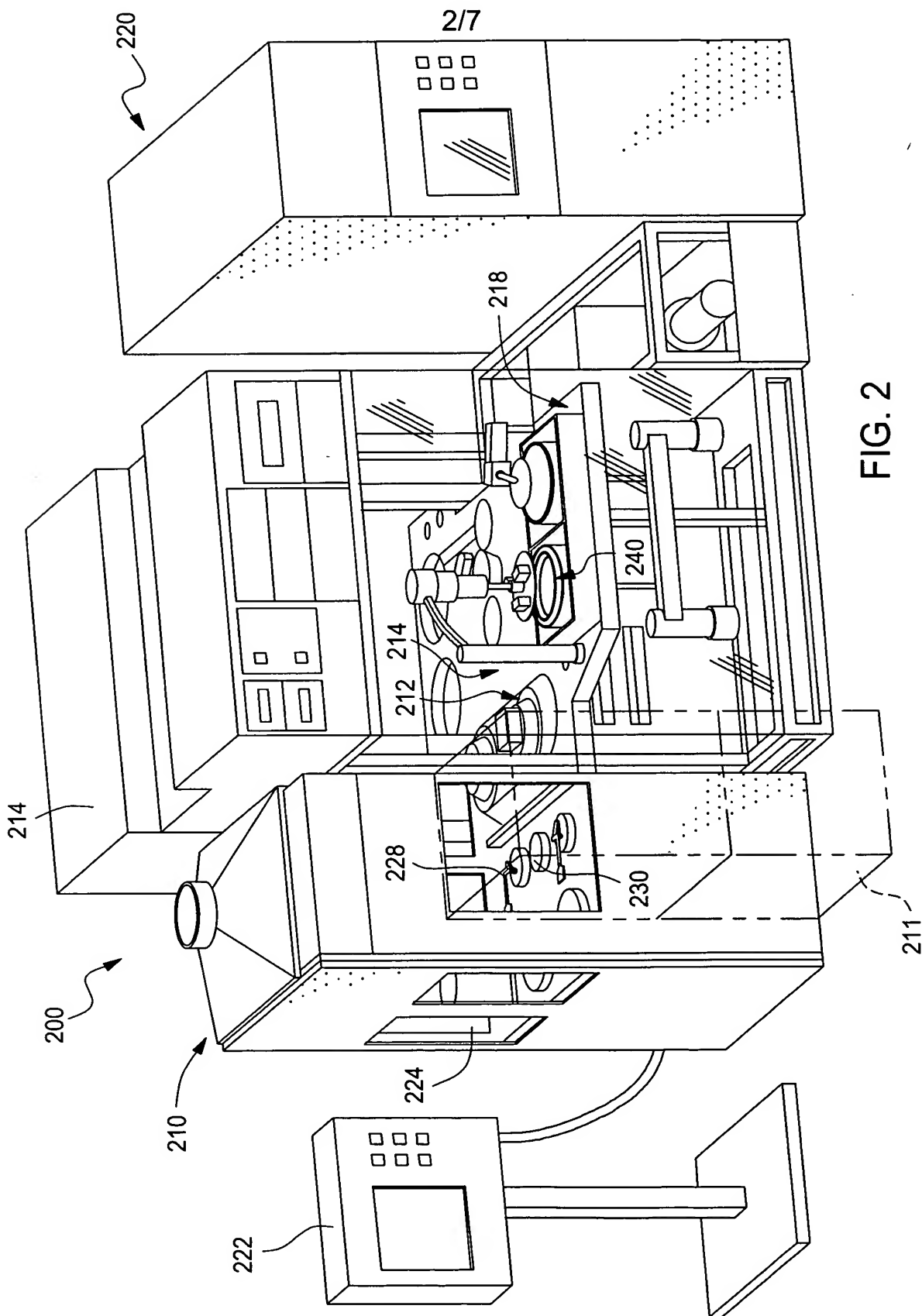
AMAT/6346/CMP/ECP/RKK
10/085,822

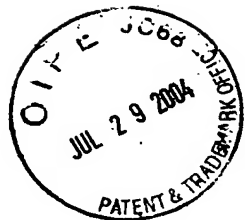
CONF. No.:2395

FEBRUARY 27, 2002

METHOD TO REDUCE THE DEPLETION OF ORGANICS IN
ELECTROPLATING BATHS

FIGURE: 2





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FIGURE: 3

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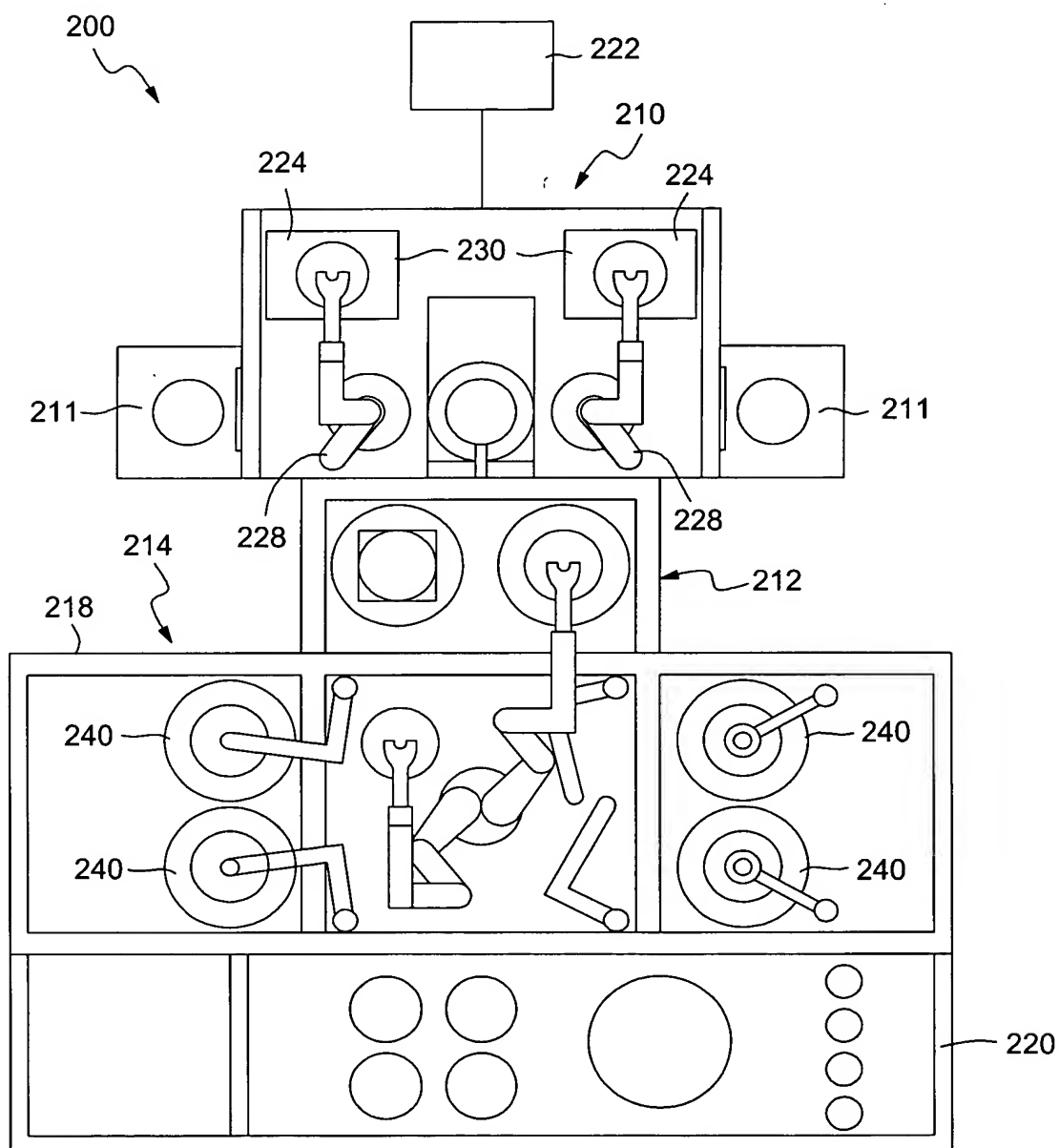


FIG. 3



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FIGURE: 4

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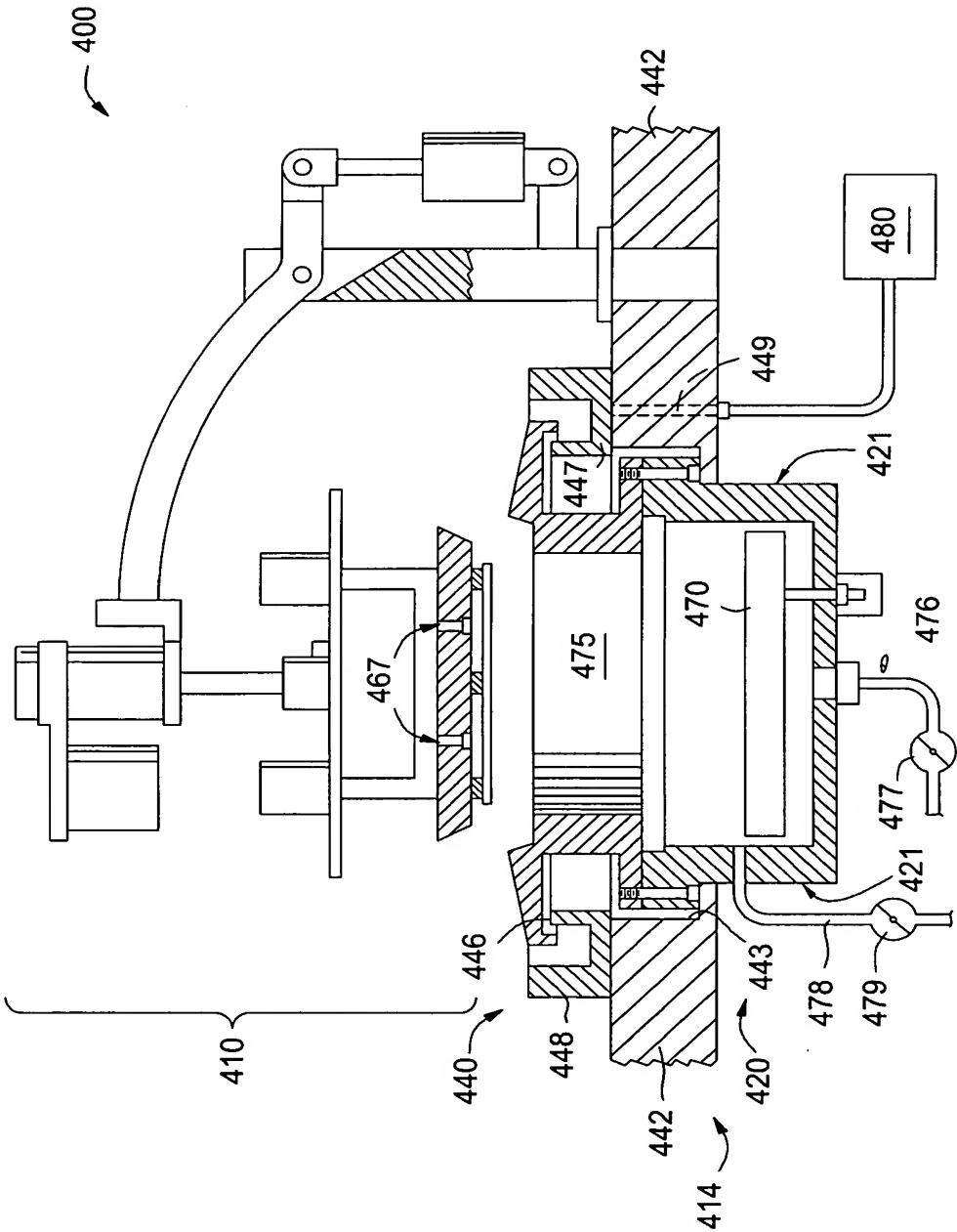
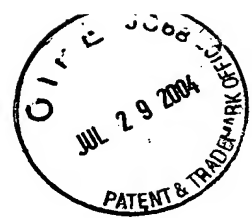


FIG. 4



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FIGURE: 5

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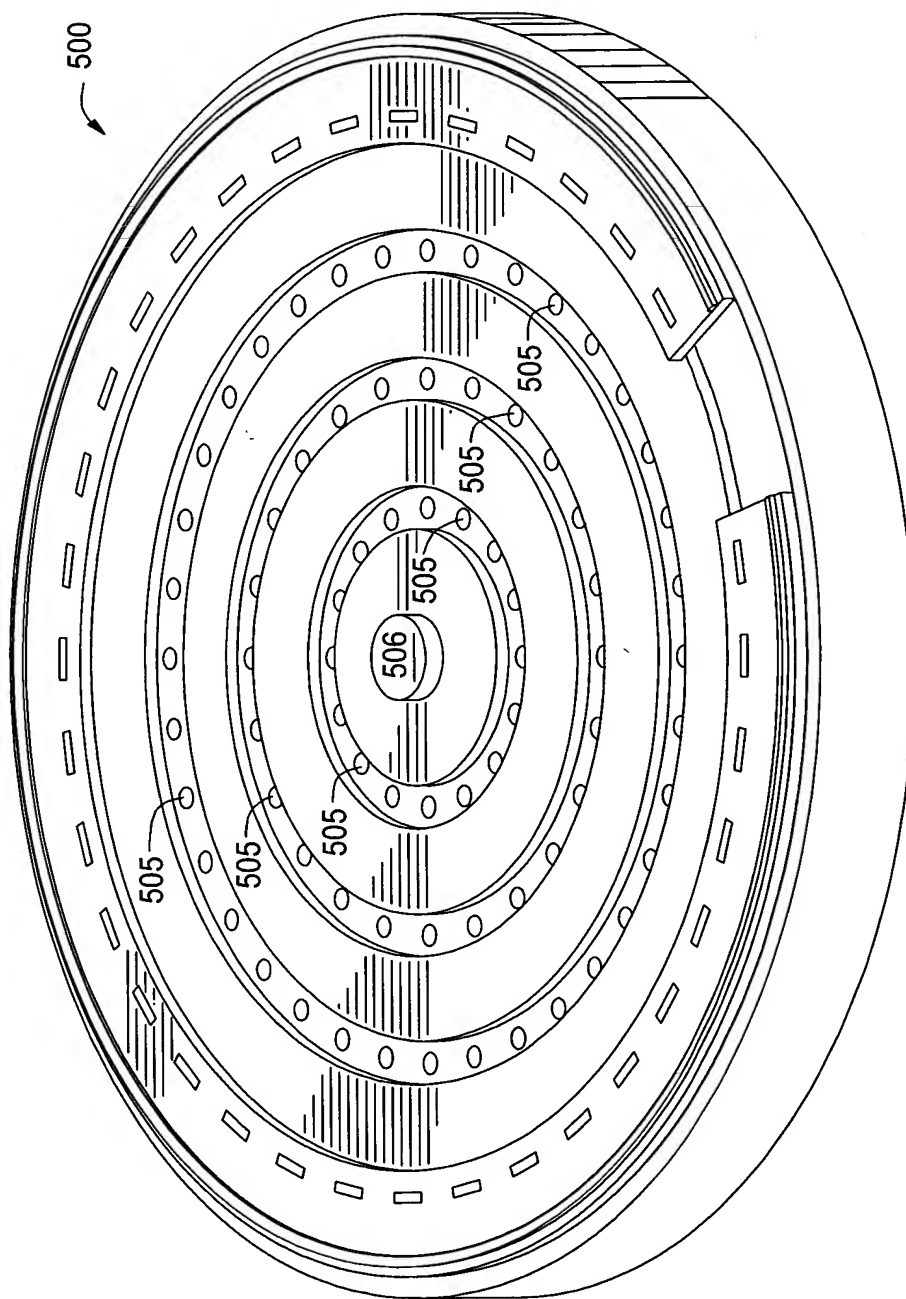
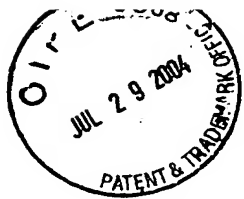


FIG. 5



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FIGURE: 6

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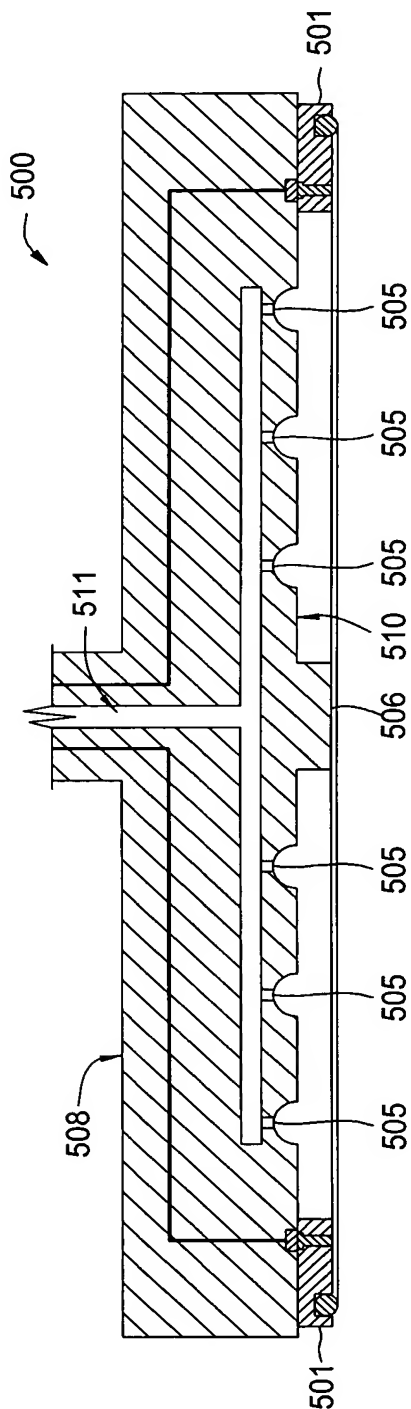


FIG. 6